### **Y5V Dielectric**

## **General Specifications**





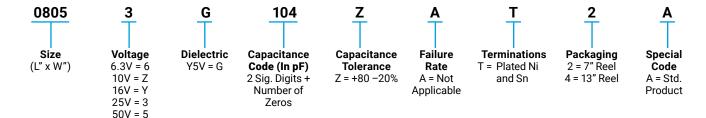
#### **GENERAL DESCRIPTION**

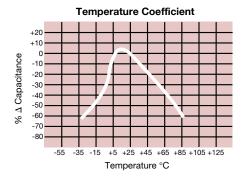
Y5V formulations are for general-purpose use in a limited temperature range. They have a wide temperature characteristic of +22% –82% capacitance change over the operating temperature range of  $-30^{\circ}$ C to  $+85^{\circ}$ C.

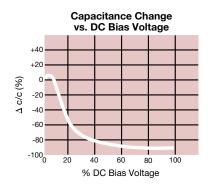
These characteristics make Y5V ideal for decoupling applications within limited temperature range.

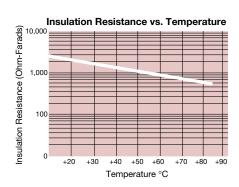


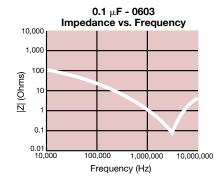
#### PART NUMBER (SEE PAGE 4 FOR COMPLETE PART NUMBER EXPLANATION)

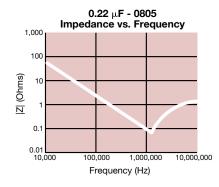


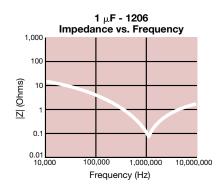












# **Y5V Dielectric**

# **Specifications and Test Methods**



Parame	ter/Test	Y5V Specification Limits	Measuring Conditions						
Operating Tem		-30°C to +85°C	Temperature Cycle Chamber						
Capac	itance	Within specified tolerance							
Dissipatio	on Factor	≤ 5.0% for ≥ 50V DC rating ≤ 7.0% for 25V DC rating ≤ 9.0% for 16V DC rating ≤ 12.5% for ≤ 10V DC rating	Freq.: 1.0 kHz ± 10% Voltage: 1.0Vrms ± .2V For Cap > 10 μF, 0.5Vrms @ 120Hz						
Insulation	Resistance	10,000MΩ or 500MΩ - $\mu$ F, whichever is less	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity						
Dielectric	Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max)						
	Appearance	No defects	Deflectio						
Resistance to	Capacitance Variation	≤ ±30%	Test Time: 30 seconds  1mm/sec  90 mm						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)							
	Insulation Resistance	≥ Initial Value x 0.1							
Solder	ability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutection for 5.0 ± 0.5						
	Appearance	No defects, <25% leaching of either end terminal							
	Capacitance Variation	≤ ±20%							
Resistance to Solder Heat	Dissipation Factor	Meets Initial Values (As Above)	Dip device in eutectic solder at 260°C for 60 seconds. Store at room temperature for 24 ± 2 hours before measuring electrical properties.						
	Insulation Resistance	Meets Initial Values (As Above)	nours before measuring electrical properties.						
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects	Step 1: -30°C ± 2°	30 ± 3 minutes					
	Capacitance Variation	≤ ±20%	Step 2: Room Temp	≤ 3 minutes					
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +85°C ± 2°	30 ± 3 minutes					
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes					
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles 24 ±2 hours at ro						
	Appearance	No visual defects	-						
	Capacitance Variation	≤ ±30%	Charge device with twice rated voltage in test chamber set at 85°C ± 2°C for 1000 hours (+48, -0)  Remove from test chamber and stabilize at room temperature for 24 ± 2 hours before measuring.						
Load Life	Dissipation Factor	≤ Initial Value x 1.5 (See Above)							
	Insulation Resistance	≥ Initial Value x 0.1 (See Above)							
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects							
	Capacitance Variation	≤ ±30%	Store in a test chamber set at 85°C ± 2°C/ 85% ± 5% relative humidity for 1000 hours (+48, -0) with rated voltage applied.						
Load Humidity	Dissipation Factor	≤ Initial Value x 1.5 (See above)							
···	Insulation Resistance	≥ Initial Value x 0.1 (See Above)	Remove from chamber and stabilize at room temperature and humidity for						
	Dielectric Strength	Meets Initial Values (As Above)	24 ± 2 hours before measuring.						



# **Y5V Dielectric**

# **Capacitance Range**



### **PREFERRED SIZES ARE SHADED**

SIZE 0201		0402				0603			0805				1206				1210												
Solderi	ng	Reflov	v Only		Ref	low/W	ave		ı	Reflow	/Wav		F	Reflow	/Wave	9	F	Reflow	Mfeve		Reflow/Wave			e					
Packagi	ing	All P	aper		Α	II Pape	er			All P	aper		Paper/Emb			ed	Paper/Embossed			Paper/Embossed		ed							
(L) Length mm (in.)		0.60 ±	0.09	1.00 ± 0.10			1.60 :	± 0.15		2.01 ± 0.20			3.20 ± 0.20			3.20 ± 0.20													
		(0.024 ±	0.004)	(0.040 ± 0.004)				(0.063 ± 0.006)				(0.079 ± 0.008)				(0.126 ± 0.008)				(0.126 ± 0.008)									
W) Width	mm	mm 0.30 ± 0.09			0.30 ± 0.09		0.30 ± 0.09			0.5	50 ± 0.	10		<u> </u>	.81 ±	0.15		,	1.25 :	£ 0.20		ì	1.60 ±	0.20		į į	2.50 :	0.20	
vv) vvidtii	(in.)	(0.011 ±			(0.020 ± 0.004)			(0.032 ± 0.006)			(0.049 ± 0.008)				(0.063 ± 0.008)				(0.098 ± 0.008)										
(t) Terminal mm (in.)		0.15 ±		0.25 ± 0.15					0.35 :			0.50 ± 0.25			0.50 ± 0.25			.50 ± 0.25											
		(0.006 ±			_ `	10 ± 0.			,	0.014 :			_ `		± 0.01	,	_ \	.020 ±					£ 0.01						
	WVDC	63	10	6	6 10 16 25 50		10	16	25	50	10 16 25 50			10 16 25 50			50	10 16 25 50											
Cap	820																			ı	-		×14/	٠					
(pF)	1000		Α																	ناسم			-VV	~					
	2200		A																_				IJ	. Î⊤					
	4700		Α																	(	_ )			_					
Cap	0.010	A	Α																		L	-							
(μF)	0.022	A				_													_		. [	t I		.					
	0.047	Α				С						_				1/								1					
	0.10				С	С				G	G	G				K								1					
	0.22									G														$\vdash$					
	0.47					С				G	G																		
	1.0			С	С	U			G	G	J			N	N	N		М	М	М				N					
	2.2				С				J					N	N			141	K	0									
	4.7												N	N	N			Р	Q	_		N	N	1					
	10.0												N	Р			Q	Q	x		Χ	Q	Q	Х					
	22.0																Q				Х	Z							
	47.0																							ш					
	WVDC	63	10	6	10	16	25	50	10	16	25	50	10	16	25	50	10	16	25	50	10	16	25	50					
SIZE 0201		01		0402					06	03			08	05		1206				1210									

Letter	Α	С	E	G	J	K	М	N	Р	Q	Х	Υ	Z		
Max.	0.33	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.78	2.29	2.54	2.79		
Thickness	(0.013)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.070)	(0.090)	(0.100)	(0.110)		
PAPER						FMBOSSED									

